Power logic 8-bit shift register; open-drain outputs

Rev. 1 — 12 July 2012

**Product data sheet** 

### 1. General description

The NPIC6C595-Q100 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and open-drain outputs. Both the shift and storage register have separate clocks. The device features a serial input (DS) and a serial output (Q7S) to enable cascading and an asynchronous reset input (MR). A LOW on MR resets both the shift register and storage register. Data is shifted on the LOW-to-HIGH transitions of the SHCP input. The data in the shift register is transferred to the storage register on a LOW-to-HIGH transition of the STCP input and to the Q7S output on a LOW-to-HIGH transition of the SHCP input. If both clocks are connected together, the shift register is always one clock pulse ahead of the storage register. Data in the storage register drives the gate of the output extended-drain NMOS transistor whenever the output enable input (OE) is LOW. A HIGH on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the registers. The open-drain outputs are 33 V/100 mA continuous current extended-drain NMOS transistors designed for use in systems that require moderate load power such as LEDs. Integrated voltage clamps in the outputs provide protection against inductive transients making the device suitable for power driver applications such as relay, solenoids and other low-current or medium-voltage loads.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
   Specified from -40 °C to +125 °C
- Low R<sub>DSon</sub>
- Eight Power EDNMOS transistor outputs of 100 mA continuous current
- 250 mA current limit capability
- Output clamping voltage 33 V
- 30 mJ avalanche energy capability
- All registers cleared with single input
- Low power consumption
- ESD protection:
  - HBM AEC-Q100-002 revision D exceeds 2500 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V

## 3. Applications

- LED sign
- Graphic status panel

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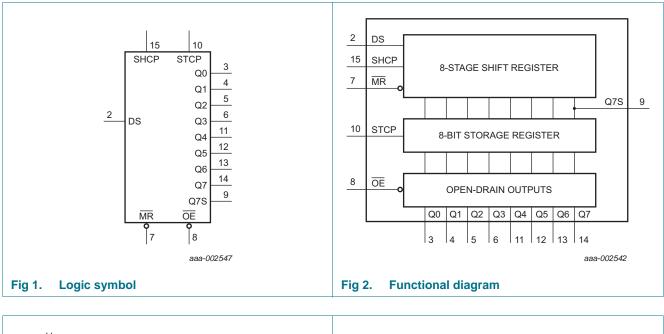
Power logic 8-bit shift register; open-drain outputs

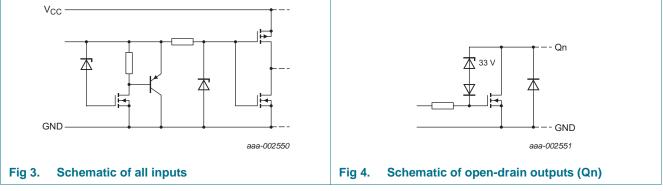
Fault status indicator

## 4. Ordering information

Table 1. Ordering information								
Type number	Package	Package						
	Temperature range	Name	Description	Version				
NPIC6C595D-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1				
NPIC6C595PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1				
NPIC6C595BQ-Q100	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1				

## 5. Functional diagram

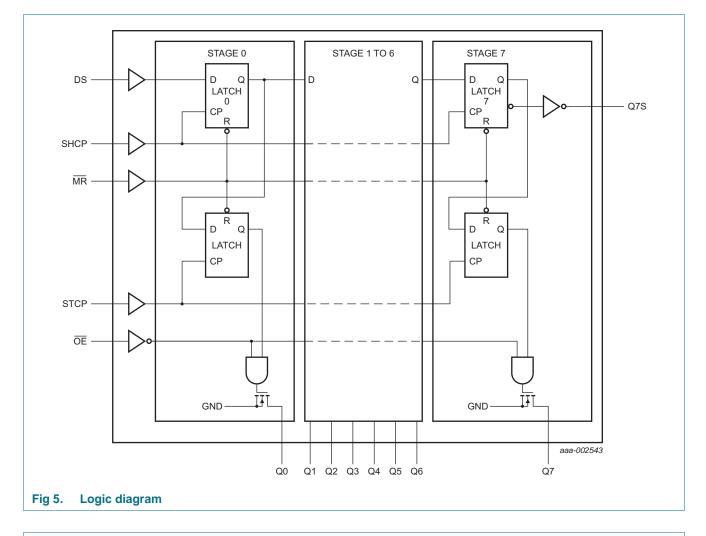


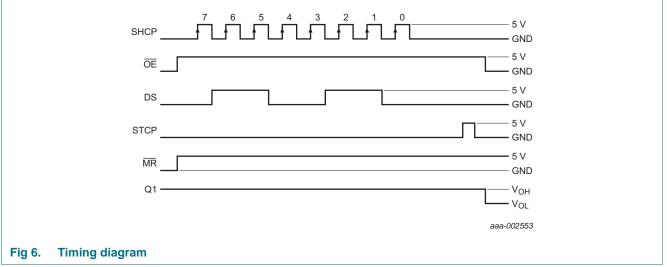


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#### **Pinning information** 6.

#### NPIC6C595-Q100 V<sub>CC</sub> GND terminal 1 index area 16 -NPIC6C595-Q100 SHCP 2 (15 DS Q0 3) (14 Q7 16 GND V<sub>CC</sub> 1 (13 DS 2 15 SHCP Q1 4) Q6 14 Q7 Q0 3 Q2 5) (12 Q5 Q1 4 13 Q6 Q3 6) (11 Q4 GND<sup>(1)</sup> Q2 5 12 Q5 7) $\overline{\mathsf{MR}}$ (10 STCP Q3 6 11 Q4 6 ω MR 7 10 STCP Ш Q7S aaa-002545 OE 8 9 Q7S aaa-002544 Transparent top view (1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND. Fig 7. Pin configuration SO16 and TSSOP16 Fig 8. **Pin configuration DHVQFN16**

### 6.2 Pin description

#### **Pin description** Table 2.

Symbol	Pin	Description
V <sub>CC</sub>	1	supply voltage
DS	2	serial data input
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	3, 4, 5, 6, 11, 12, 13, 14	parallel data output (open-drain)
MR	7	master reset (active LOW)
ŌĒ	8	output enable input (active LOW)
Q7S	9	serial data output
STCP	10	storage register clock input
SHCP	15	shift register clock input
GND	16	ground (0 V)

## 6.1 Pinning

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## 7. Limiting values

#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.3	+7.0	V
V <sub>DS</sub>	drain-source voltage	power EDNMOS drain-source voltage	<u>[1]</u> -	+33	V
I <sub>d(SD)</sub>	source-drain diode current	continuous	-	250	mA
		pulsed	[2] -	500	mA
I <sub>D</sub>	drain current	T <sub>amb</sub> = 25 °C			
		continuous; each output; all outputs on	-	100	mA
		pulsed; each output; all outputs on	<u>[2]</u> _	250	mA
I <sub>DM</sub>	peak drain current	single output; $T_{amb} = 25 \ ^{\circ}C$	[2] _	250	mA
E <sub>AS</sub>	non-repetitive avalanche energy	single pulse; see <u>Figure 9</u>	[3] _	30	mJ
I <sub>AL</sub>	avalanche current	see <u>Figure 9</u>	[3] _	200	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	<u>[4]</u>		
		SO16	-	800	mW
		TSSOP16	-	725	mW
		DHVQFN16	-	1825	mW
		T <sub>amb</sub> = 125 °C	<u>[4]</u>		
		SO16	-	160	mW
		TSSOP16	-	145	mW
		DHVQFN16	-	365	mW

[1] Each power EDNMOS source is internally connected to GND.

[2] Pulse duration  $\leq$  100  $\mu s$  and duty cycle  $\leq$  2 %.

 $[3] V_{DS} = 15 \text{ V}; \text{ starting junction temperature } (T_j) = 25 \text{ °C}; \text{ L} = 1.5 \text{ H}; \text{ avalanche current } (I_{AL}) = 200 \text{ mA}.$ 

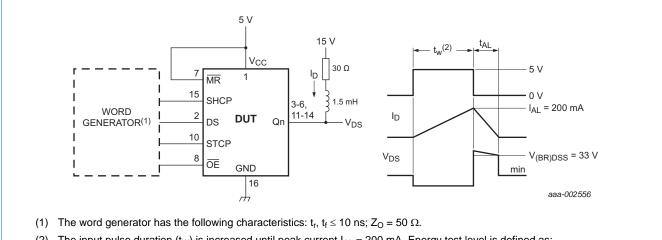
[4] For SO16 packages: above 25 °C the value of P<sub>tot</sub> derates linearly with 6.4 mW/°C. For TSSOP16 packages: above 25 °C the value of P<sub>tot</sub> derates linearly with 5.8 mW/°C.

For DHVQFN16 packages: above 25 °C the value of P<sub>tot</sub> derates linearly with 14.6 mW/°C.

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(2) The input pulse duration ( $t_W$ ) is increased until peak current  $I_{AL}$  = 200 mA. Energy test level is defined as: E<sub>AS</sub> =  $I_{AL} \times V_{(BR)DSS} \times t_{AL}/2$  = 30 mJ.

Fig 9. Test circuit and waveform for measuring single-pulse avalanche energy

## 8. Recommended operating conditions

<b>T</b>			
Table 4.	Recommended	operating	conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		4.5	-	5.5	V
VI	input voltage		0	-	5.5	V
I <sub>D</sub>	drain current	pulsed drain output current; V <sub>CC</sub> = 5 V; T <sub>amb</sub> = 25 °C; all outputs on	<u>[1][2]</u> _	-	250	mA
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C

[1] Pulse duration  $\leq$  100  $\mu$ s and duty cycle  $\leq$  2 %.

[2] Technique should limit  $T_j - T_{amb}$  to 10 °C maximum.

## 9. Static characteristics

#### Table 5.Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	$V_{CC} = 5.$	Unit		
			Min	Тур	Мах	
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	0.85V <sub>CC</sub>	-	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	-	0.15V <sub>CC</sub>	V
V <sub>OH</sub> HIGH-level output voltage		serial data output Q7S; $V_I = V_{IH}$ or $V_{IL}$				
	output voltage	$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.49	-	V
		$I_O = -4$ mA; $V_{CC} = 4.5$ V	4.0	4.2	-	V

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Symbol	Parameter	Conditions		V <sub>CC</sub> = 5.0 V; T <sub>amb</sub> = 25 °C			Unit
					Тур	Max	
V <sub>OL</sub>		serial data output Q7S; $V_I = V_{IH}$ or $V_{IL}$					
	voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$		-	0.005	0.1	V
		$I_0 = 4 \text{ mA}; V_{CC} = 4.5 \text{ V}$		-	0.3	0.5	V
I <sub>IH</sub>	HIGH-level input current	$V_{CC} = 5.5 \text{ V}; \text{ V}_{I} = V_{CC}$		-	-	1	μΑ
I <sub>IL</sub>	LOW-level input current	$V_{CC} = 5.5 \text{ V}; V_{I} = 0 \text{ V}$		-	-	-1	μA
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = 1 mA		33	37	-	V
V <sub>SD</sub>	source-drain voltage	diode forward voltage; $I_F = 100 \text{ mA}$		-	0.85	1.2	V
I <sub>CC</sub>	supply current	logic supply current; $V_{CC} = 5.5 V$ ; $V_I = V_{CC}$ or GND					
		all outputs off		-	0.004	200	μΑ
		all outputs on		-	0.006	500	μA
		all outputs off; SHCP = 5 MHz; $C_L = 30$ pF; see Figure 14 and Figure 16		-	0.75	5	mA
I <sub>O(nom)</sub>	nominal output current	$V_{DS}$ = 0.5 V; $T_{amb}$ = 85 °C; $I_{out}$ = $I_D$	<u>[1][2][3]</u>	-	140	-	mA
I <sub>DSX</sub>	drain cut-off	$V_{CC} = 5.5 \text{ V}; V_{DS} = 30 \text{ V}$		-	0.002	0.2	μA
	current	$V_{CC}$ = 5.5 V; $V_{DS}$ = 30 V; $T_{amb}$ = 125 $^{\circ}C$		-	0.15	0.3	μA
R <sub>DSon</sub>	drain-source	see Figure 17 and Figure 18	[1][2]				
	on-state resistance	$V_{CC} = 4.5 \text{ V}; \text{ I}_{D} = 50 \text{ mA}$		-	3.0	9	Ω
	10010100	$V_{CC}$ = 4.5 V; I <sub>D</sub> = 50 mA; T <sub>amb</sub> = 125 °C			5.4	12	Ω
		V <sub>CC</sub> = 4.5 V; I <sub>D</sub> = 100 mA		-	3.1	10	Ω

#### Table 5. Static characteristics ...continued

[1] Technique should limit  $T_j - T_{amb}$  to 10 °C maximum.

[2] These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts.

[3] Nominal output current is defined for a consistent comparison between devices from different sources. It is the current that produces a voltage drop of 0.5 V at T<sub>amb</sub> = 85 °C.

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## **10. Dynamic characteristics**

#### Table 6. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); For test circuit see Figure 14.

Symbol	Parameter	Conditions		V <sub>CC</sub> = \$	5.0 V; T <sub>amb</sub>	V; T <sub>amb</sub> = 25 °C	
				Min	Тур	Max	
t <sub>PLH</sub>	LOW to HIGH propagation delay	$\overline{OE}$ to Qn; I <sub>D</sub> = 75 mA; see <u>Figure 10</u> and <u>Figure 19</u>		-	97	-	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	$\overline{OE}$ to Qn; I <sub>D</sub> = 75 mA; see <u>Figure 10</u> and Figure 19		-	9	-	ns
t <sub>r</sub>	rise time	$\overline{OE}$ to Qn; I <sub>D</sub> = 75 mA; see <u>Figure 10</u> and <u>Figure 19</u>		-	60	-	ns
t <sub>f</sub>	fall time	$\overline{OE}$ to Qn; I <sub>D</sub> = 75 mA; see <u>Figure 10</u> and Figure 19		-	18	-	ns
t <sub>pd</sub>	propagation delay	SHCP to Q7S; $I_D = 75$ mA; see Figure 11	<u>[1]</u>	-	5	-	ns
f <sub>max</sub>	maximum frequency	SHCP; I <sub>D</sub> = 75 mA; see <u>Figure 11</u>	[2]	-	-	10	MHz
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 100 mA; dl/dt = 10 A/μs; see <u>Figure 13</u>	<u>[3][4]</u>	-	120	-	ns
t <sub>a</sub>	reverse recovery current rise time	I <sub>F</sub> = 100 mA; dl/dt = 10 A/μs; see <u>Figure 13</u>	<u>[3][4]</u>	-	100	-	ns
t <sub>su</sub>	set-up time	DS to SHCP; see Figure 12		20	-	-	ns
t <sub>h</sub>	hold time	DS to SHCP; see Figure 12		20	-	-	ns
t <sub>W</sub>	pulse width			40	-	-	ns

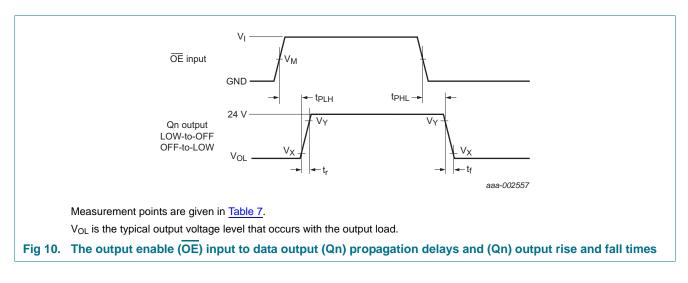
[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] This is the maximum serial clock frequency assuming cascaded operation where serial data is passed from one stage to a second stage. The clock period allows for SHCP → Q7S propagation delay and setup time plus some timing margin.

[3] Technique should limit  $T_j - T_{amb}$  to 10 °C maximum.

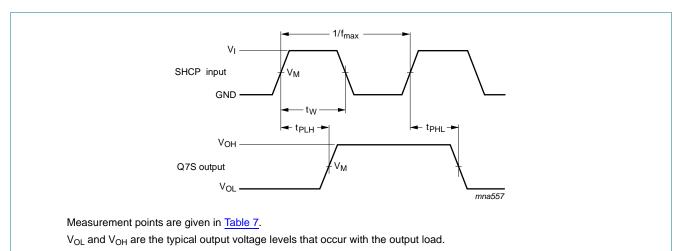
[4] These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts.

### 10.1 Test circuits and waveforms



## NPIC6C595-Q100

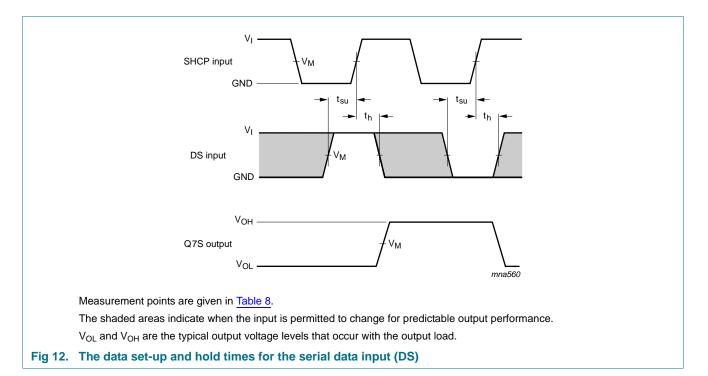
### Power logic 8-bit shift register; open-drain outputs



## Fig 11. The shift clock (SHCP) to serial data output (Q7S) propagation delays, the shift clock pulse width and maximum shift clock frequency

#### Table 7. Measurement points

Supply voltage	Input	Output			
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
5 V	0.5V <sub>CC</sub>	0.5V <sub>DS</sub>	0.1V <sub>DS</sub>	0.9V <sub>DS</sub>	

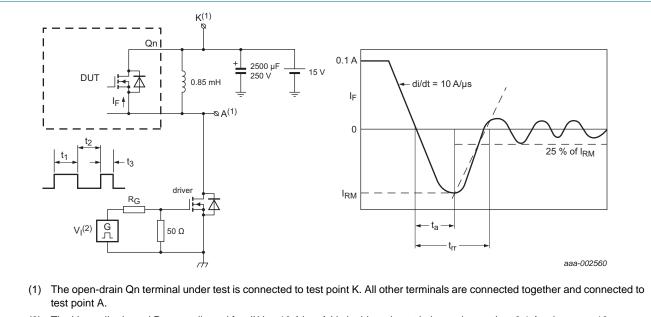


#### Table 8. Measurement points

Supply voltage	Input	Output
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>

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Product data sheet

#### Power logic 8-bit shift register; open-drain outputs



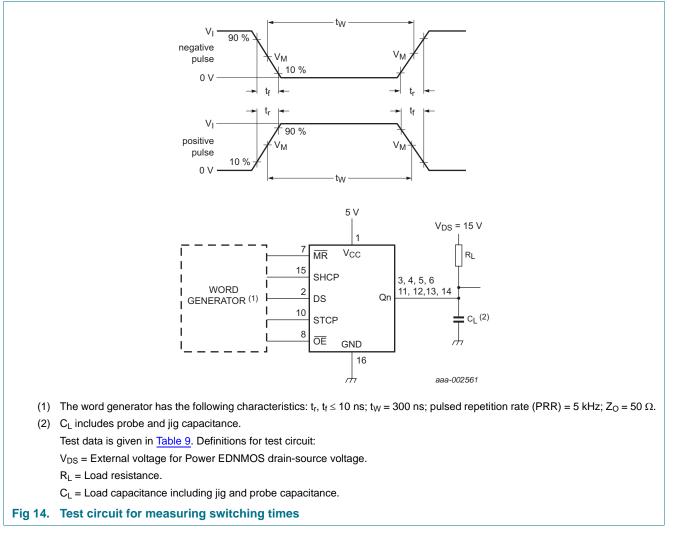
(2) The V<sub>I</sub> amplitude and R<sub>G</sub> are adjusted for dI/dt = 10 A/ $\mu$ s. A V<sub>I</sub> double-pulse train is used to set I<sub>F</sub> = 0.1 A, where t<sub>1</sub> = 10  $\mu$ s, t<sub>2</sub> = 7  $\mu$ s and t<sub>3</sub> = 3  $\mu$ s.

Fig 13. Test circuit and waveform for measuring reverse recovery current

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## NPIC6C595-Q100

### Power logic 8-bit shift register; open-drain outputs

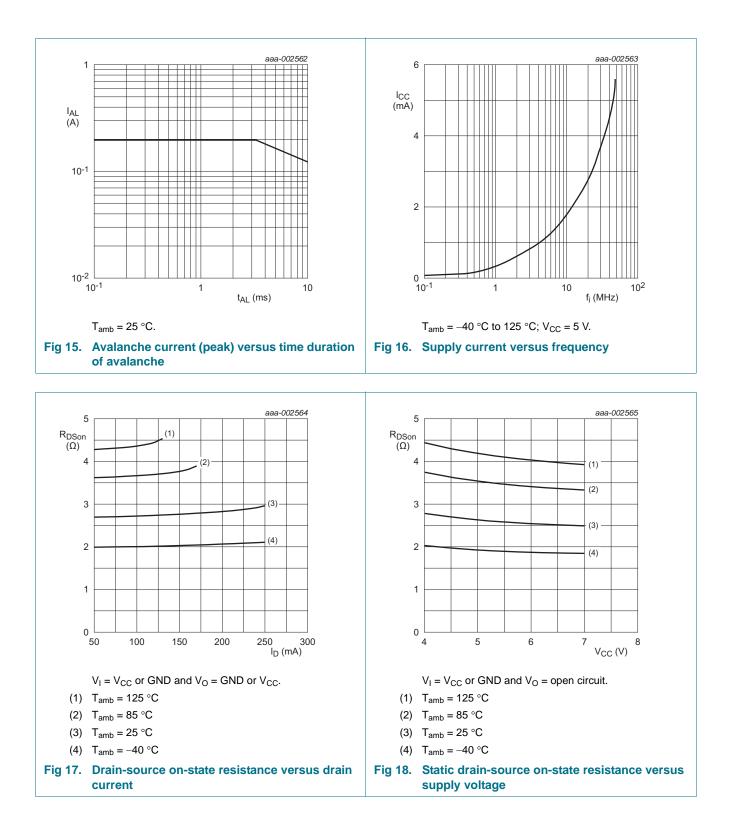


#### Table 9. Test data

Supply voltage	Input			Load		
	VI	t <sub>r</sub> , t <sub>f</sub>	V <sub>M</sub>	CL	RL	
5 V	5 V	≤ 10 ns	50 %	30 pF	200 Ω	

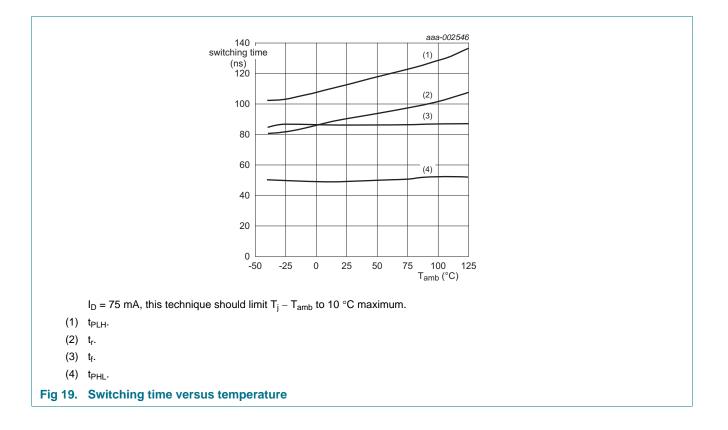
## NPIC6C595-Q100

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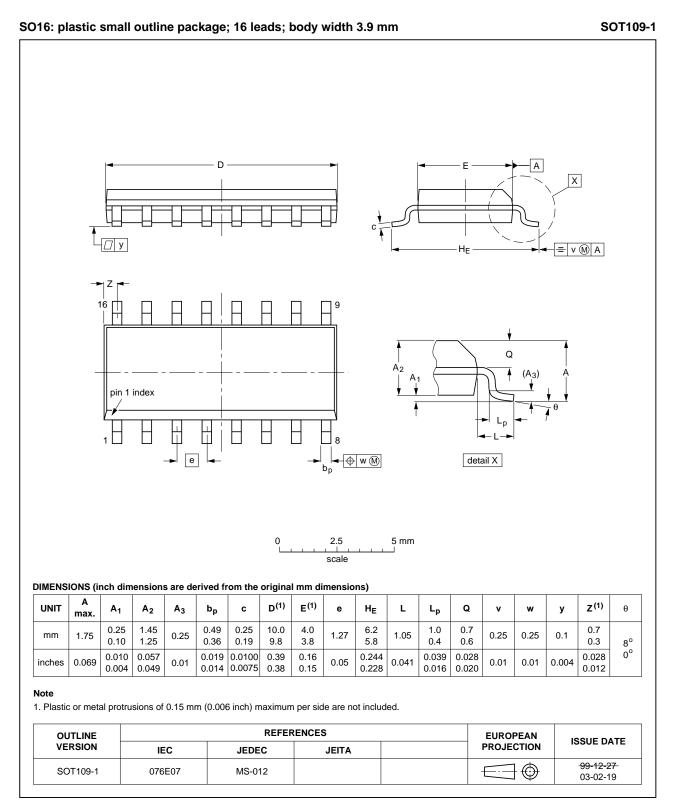
## NPIC6C595-Q100

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Power logic 8-bit shift register; open-drain outputs

## 11. Package outline

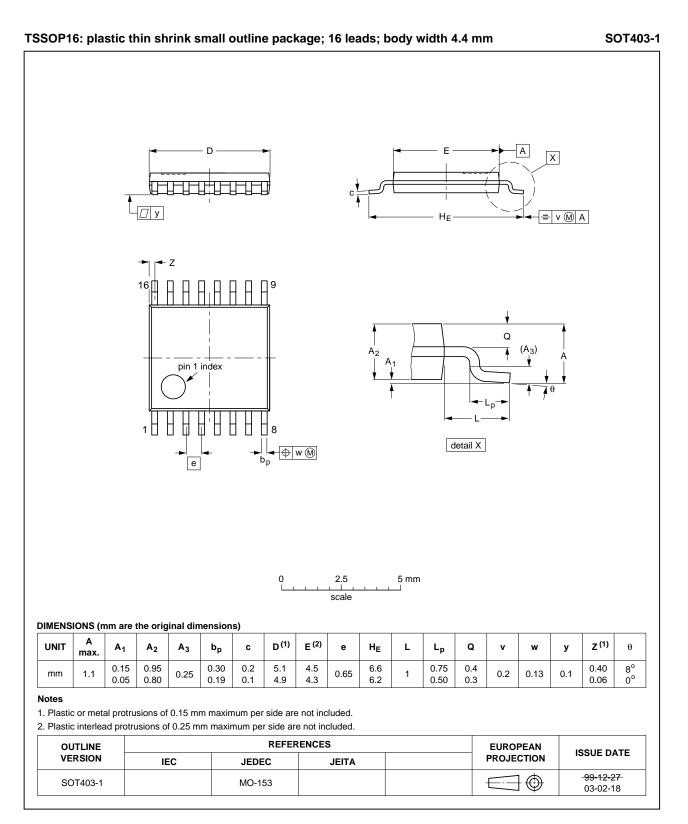


#### Fig 20. Package outline SOT109-1 (SO16)

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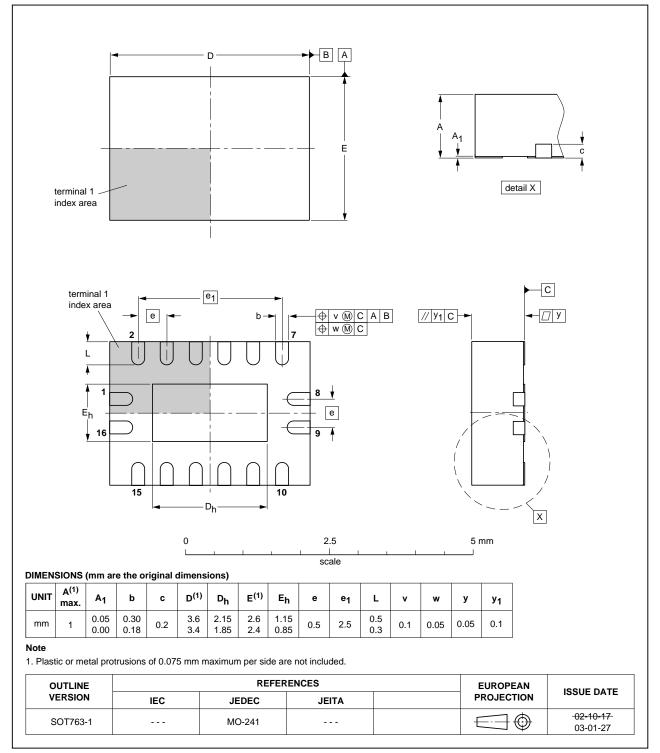


#### Fig 21. Package outline SOT403-1 (TSSOP16)

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#### DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 22. Package outline SOT763-1 (DHVQFN16)

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## **12. Abbreviations**

AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal Oxide SemiconductorDUTDevice Under TestEDNMOSExtended Drain Negative Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelTTLTransistor-Transistor Logic	Table 10. Abbreviations				
CMOSComplementary Metal Oxide SemiconductorDUTDevice Under TestEDNMOSExtended Drain Negative Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body Model	Acronym	Description			
DUTDevice Under TestEDNMOSExtended Drain Negative Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body Model	CDM	Charged Device Model			
EDNMOSExtended Drain Negative Metal Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body Model	CMOS	Complementary Metal Oxide Semiconductor			
ESD     ElectroStatic Discharge       HBM     Human Body Model	DUT	Device Under Test			
HBM Human Body Model	EDNMOS	Extended Drain Negative Metal Oxide Semiconductor			
	ESD	ElectroStatic Discharge			
TTL Transistor-Transistor Logic	HBM	Human Body Model			
	TTL	Transistor-Transistor Logic			

## **13. Revision history**

Table 11. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
NPIC6C595_Q100 v.1	20120712	Product data sheet	-	-		

Power logic 8-bit shift register; open-drain outputs

## 14. Legal information

### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

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